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Product Specification [产品规格书]:	Document No	PS-1255-01
Subject [主题]:	Date Issued	2019/06/09
1.25mm Pitch 1255 Series Connector Specification	Date Revised	2018/05/26
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This specification is referred to the 1.25mm series wire to board connector

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#### 【1.适用范围 Scope】

此种规格包括 1.25mm Pitch 1255 Series 连接器规格说明.

This Specification Covers the 1.25mm Pitch 1255 Series Connector Specification.

#### 【2.规格与料号 Spec and Part number】

No. Picture of Product
No. Picture of Product
X
K-N0XX
NOXX
xx-xxxx
×

#### 【3.材质与表面处理 Disposal of Material and surface】

规格内容		材 质	表面处理		
Specification		Materials	Disposal of Surface		
			1. Nickel: Over 30μ". Tin: Over 70μ".		
端子/Terr	ninal	磷铜(C5191)/Phosphor Bronze	2.Gold- Plated: 1~3u" Nickel: Over		
			30μ″		
胶壳/Hou	ısing	PA66	UL 94V-0		
	Base	High Temperature Plastic	UL 94V-0		
针座/Wafer	PIN	黄铜(C2680)/Brass	1. Gold Flash / Over 30μ″ Nickel 2. Over Tin 70μ″ / Over 30μ″ Nickel		
	Solder tab	黄铜(C2680)/Brass	Over Tin 70µ" Plated / Over 30µ"		
	Sold tab	× 47(02000)/ Blass	Nickel		

# (上述参数请以工程图为准/Please Refer to the Project drawing for the above Specification)

#### 【4. 额定等级 Ratings and applicable wires】

项 目【Item】	规 格【Standard】		
额定电压 Rated Voltage (Max.)	200V	[AC/DC]	
额定电流 Rated Current (Max.)	1A	[AC/DC]	
使用温度范围 Ambient temperature Range	-40°C ~+105°C		
适用线径 Applicable wire insulation O.D	AWG #28~32 Insulation O.D. 0.90mm(Max.)		

【\*升温时含端子.Including terminal temperature rise. 】

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#### 【5.性能 PERFORMANCE】

#### 5-1. 电气的性能 Electrical Performance.

项 目		条件	规 格
	【Item】	[Test Condition]	[Requirement]
5-1-1	接触阻抗 Contact	公母配合,开放电压 20mV 以下,电流 10mA 检测连接器 A~B 区. Mate connectors, measure by dry circuit, 20mV MAX, 10mA. (Based upon EIA-364-06A).	Initial: 40 milliohms Max. After Test:
	Resistance	A B	80 milliohms Max.
5-1-2	绝缘阻抗 Insulation Resistance	公母配合,在相邻端子,端子与地片之间,使用 500V 的直流电,检测连接器. Mate connectors, apply 500V DC between adjacent terminal or ground. (Based upon EIA-364-21B / MIL-STD-202 Method 302 Cond.B)	100 Megohms Min.
5-1-3	耐电压 Dielectric Strength	公母配合,在相邻端子,端子与地片之间,使用 500V 的交流电 1 分锺,检测连接器. Mate connectors, apply 500V AC for 1 minute between adjacent terminal or ground. (Based upon EIA-364-20A / MIL-STD-202 Method 301)	不出现中断等情况 No Breakdown and Flashover
5-1-4	resistance on	铆线后之端子,开放电压 20mV 以下,电流 10mA 检测连接器. Crimp the applicable wire on to the terminal measure by dry circuit 20mV MAX, 10mA.	10 milliohms Max.

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#### 5-2. 机械的性能 Mechanical Performance.

	项 目	规 格	
	[Item]	条 件 【Test Condition】	【Requirement】
5-2-1	插拔力 Insertion & withdraw Force	以每分锺 25.4±3mm 的速率插入和拔出. Insert and withdraw Connectors at the speed rate of 25.4±3mm/minute.	
5-2-2	端子保持力 Terminal/ Housing Retention Force	以每分 25.4±3mm 的速率,将端子从 Housing 内轴向拔出的力量. Apply axial pull out force at the speed rate of 25.4±3mm/minute on the terminal assembled in the housing.	4.9N {0.5kgf} Min.
5-2-3	端子插入力 Terminal Insertion Force	铆线后之端子插入 Housing 所需最大力量. Insert the crimped terminal into the housing.	4.9N {0.5kgf} Max.
5-2-4	Pin 针保持力 Pin Retention Force	以每分 25.4±3mm 的速率,将 PIN 针从 Wafer 内轴向拔出的力量. Apply axial push force at the speed rate of 25.4±3mm/minute.  PUSH	2.94N {0.30kgf} min.

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	项 目	条件	规	1	各	
	【Item】	[Test Condition]	【Requ	ireme	nt]	
		固定铆线后的端子,使电线与端子分离时所需的最	AWG#	#28	#30	#32
	端子压着强度 Tensile strength	小力量. Fix the crimped terminal, apply axial pull out force on the wire. (Do not crimp insulation part).	Spec.kgf. Min.	1.0	0.5	0.3
5-2-5	(Crimped connections)	PULL	Note> As for sizes in this sp	ecifica	ition d	

## 5-3. 环境性能及其它 Environmental Performance and Others.

	项目	<del>条</del> 件	规	格
	[Item]	【Test Condition】	[Requirement]	
5-3-1	重复插拔 Repeated Insertion/ Withdrawal	以每分锺不超过 10 次的速率,将公母插拔 30 次. When mated up to 30 cycles repeatedly by the rate of 10 cycles per minute.	接触阻抗 Contact Resistance	80 milliohms Max.
5-3-2	温升测试 Temperature Rise	温升测试:公母连接器配合后,加载额定电流直到温度上升到稳定状态,然后再测量温升(EIA364-70,Method 1) Mating connectors shall be energized at rating current until thermal stability is achieved, and then measured the termperature rise. (EIA364-70,Method 1)	温升测试 Temperature rise	30°C Max.
5-3-3	振动测试 Vibration test	振幅: 1.5mm P-P 时间: 10~55~10 HZ in 1 minute 持续时间: 每轴向 2 小时 Amplitude: 1.5mm P-P Sweep time: 10~55~10 HZ in 1 minute	外观 Appearance 接触阻抗 Contact Resistance	无异状 No Damage 80 milliohms Max.
		Duration: 2 hours in each X.Y.Z axials. (Based upon EIA-364-28B/MIL-STD-202 Method 213B Cond.A)	But RAI	1 micro- second Max.
			外观	无异状
		在 X.Y.Z 上 6 个方向上,以 490m/s2(50g 的力量)	Appearance	No Damage
5-3-4	冲击下各 3 回.490m/s2{50G}, 3 strokes in each 接触阻	Contact	80 milliohms Max.	
		Method 213B Cond.A)	瞬断 Discontinuity	1 micro- second Max.

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			AL and	T: E-415	
		105 L 2% OS haven	外观	无异状 No Damage	
5-3-5	耐热性	105±2℃,96 hours.	Appearance	No Damage	
	Heat Resistance	(Based upon MIL-STD-202 Method 108A	接触阻抗	80 milliohms	
		Cond.A)	Contact	Max.	
			Resistance		
			外观	无异状	
	耐寒性	-40±5℃,96 hours.	Appearance	No Damage	
5-3-6		( Based upon EIA-364-105)	接触阻抗	80 milliohms	
	Cold Resistance	( based upon EIA-304-103)	Contact		
			Resistance	Max.	
		用序 <b>. 40.1.3</b> ℃	外观	无异状	
		温度: 40±2℃ 湿度: 90~95%(RH)	Appearance	No Damage	
			接触阻抗	80 milliohms	
	耐湿性	持续时间: 96 hours	Contact Resistance	Max.	
5-3-7		Temperature: 40±2°C	耐电压	Must meet	
	Humidity	Relative Humidity: 90~95%	Dielectric	5-1-3	
		Duration: 96 hours	Strength	5-1-5	
		(Based upon EIA-364-31A/MIL-STD-202	绝缘阻抗 Insulation	100 Megohms	
		Method 103B Cond.B)	Resistance	Min.	
	从-40℃持续 30 分锺升至+105℃持续 30 分锺		外观	无异状	
	温度变化 Temperature	循环 5 次.	Appearance	No Damage	
5-3-8		5 cycles of: a) -40°C 30 minutes.			
	Cycling	b) +105°C 30 minutes.	接触阻抗	80 milliohms	
	C/ Cg	(Based upon EIA-364-32B)	Contact	Max.	
		, ,	Resistance	T. B. W.	
		在温度 35±2℃,盐水浓度 5±1%下,盐水喷雾	外观	无异状	
5-3-9	盐水喷雾 Salt Spray	24±1 小时.	Appearance	No Damage	
		5±1% solution at 35±2℃.	接触阻抗	80 milliohms	
		(Based upon EIA-364-26B/MIL-STD-202		Max.	
		Method 101D Cond.B).	Resistance		
5-3-10		焊接时间:3~5 秒.		浸渍面积需	
	焊锡附着性	焊接温度: 245±5℃.		95%以上	
	Solder-			95% of	
2-2-10	ability	Solder Temperature: 245±5°C.	Solder Wetting	immersed area	
	ability	(Based upon EIA-364-52)		must show no	
		(based upon LIA-304-32)		voids, pin holes.	

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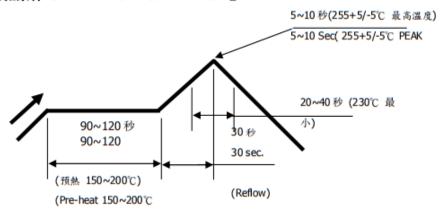
	项 目	条 件	规	格
[Item]		[Test Condition]	[Requirement]	
		焊接时间: 5~10 秒.		
5-3-11	焊锡耐热性	焊接温度: 255+5/-5℃.	外观 Appearance	无异状 No Damage
	Solder-	Solder- Soldering time:5~10 sec solder.		
	Resistance	Temperature:255+5/-5℃.		
		(Based upon EIA-364-56A)		

#### 【6.综合插入力及拔出力 INSERTION/WITHDRAWAL FORCE】 < Connector mating force>

PIN 数 No. of CKT	初次插入力(最大值) First Insertion (kgf Max.)	30 次拔出力(最小值) 30 <sup>th</sup> Withdrawal (kgf Min.)	PIN 数 No. of CKT	初次插入力(最大值) First Insertion (kgf Max.)	30 次拔出力(最小值) 30 <sup>th</sup> Withdrawal (kgf Min.)
2	0.4	0.08	9	1.8	0.36
3	0.6	0.12	10	2.0	0.4
4	0.8	0.16	20	4.0	0.8
5	1.0	0.20	21	4.2	0.84
6	1.2	0.24	30	6.0	1.20
7	1.4	0.28	41	8.2	1.64
8	1.6	0.32	51	10.2	2.04

注: 以上插拔次数为 30 次 Note: Insertion and Withdrawal for 30Cycles

## 【7. SMT 回流条件 SMT REFLOW CONDITION】



温度条件曲线图/ 基板上温度

#### TEMPERATURE CONDITION GRAPH/ (TEMPERATURE ON BOARD PATTERN SIDE)

注记: 由于 P.C 板等焊接装置改变条件,所以请预先用自己的装置检查回流焊的条件.

Notes: Please check the reflow soldering condition by your own devices beforehand. Because the condition changes by the soldering devices, P.C. boards, and so on.

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